

150V N-Channel Enhancement Mode MOSFET

Voltage

150 V

Current

42 A

Features

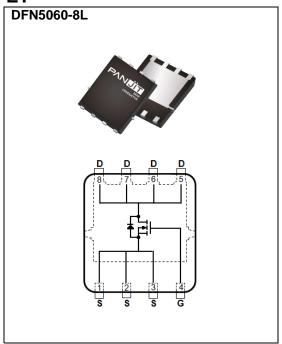
- RDS(ON), VGS@10V, ID@20A<21m Ω
- RDS(ON), VGS@7V, ID@10A<27m Ω
- Excellent FOM
- Standard Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: DFN5060-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.08 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	150	- V	
Gate-Source Voltage		V _{GS}	±20	V	
Continuous Drain Current(Note 3)	T _C =25°C		42		
	T _C =100°C	l _D	30	Α	
Pulsed Drain Current(Note 1)	Tc=25°C	I _{DM}	110		
Power Dissipation	Tc=25°C	D-	94	W	
	T _C =100°C	Po	47		
Continuous Drain Current(Note 4)	T _A =25°C	I _D	8	А	
	T _A =70°C		6.7		
Power Dissipation	T _A =25°C	Po	3.3	W	
	T _A =70°C		2.3		
Single Pulse Avalanche Current(Note 5)		las	11.2	Α	
Single Pulse Avalanche Energy ^(Note 5)		Eas	12	mJ	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~175	°C	
Thermal Resistance ^(Note 4)	Junction to Case	R _{θJC}	1.6	°C/W	
	Junction to Ambient	$R_{\theta JA}$	45		



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	150	-	-	V	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	2	3	4	V	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A	ı	17	21	mΩ	
		V _{GS} =7V, I _D =10A	ı	20	27		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =150V, V _{GS} =0V	-	-	1	uA	
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA	
Dynamic ^(Note 6)							
Total Gate Charge	Q_g	V _{DS} =75V, I _D =20A,	-	36	47	nC	
Gate-Source Charge	Q_{gs}		-	13	-		
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	ı	8	ı		
Input Capacitance	Ciss)/ 75\/)/ O\/	ı	2118	2753	pF	
Output Capacitance	Coss	V _{DS} =75V, V _{GS} =0V,	-	150	225		
Reverse Transfer Capacitance	Crss	f=1MHz	-	10	-		
Gate resistance	Rg	f=1MHz	-	0.9	-	Ω	
Turn-On Delay Time	td _(on)	V _{DS} =75V, I _D =20A,	-	12	-	ns	
Turn-On Rise Time	tr		-	31	-		
Turn-Off Delay Time	td(off)	$V_{GS}=10V, R_{G}=3\Omega$	-	24	-		
Turn-Off Fall Time	tf	(Note 2)	-	31	-		
Drain-Source Diode							
Diode Forward Current	Is	Tc=25°C	1	ı	42	А	
Pulsed Diode Forward Current	I _{SM}	1c=25 C	1	ı	110		
Diode Forward Voltage	V_{SD}	Is=20A, V _{GS} =0V	-	0.85	1.3	V	
Reverse Recovery Time	Trr	V _{DD} =75V,V _{GS} =0V	-	90	1	ns	
Reverse Recovery Charge	Qrr	Is=20A,dIs/dt=100A/us	-	220	-	nC	

NOTES:

- 1. Pulse width \leq 100us, Duty cycle \leq 2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an $R_{\theta JC} = 1.6$ °C/W.
- 4. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. E_{AS} is calculated based on the condition of L=1mH, I_{AS}=4.9A, V_{DD}=30V, V_{GS}=10V. 100% test at L=0.1mH, I_{AS}=11.2A in production.
- 6. Guaranteed by design, not subject to production testing.



TYPICAL CHARACTERISTIC CURVES

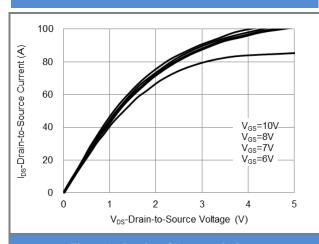


Fig.1 On-Region Characteristics

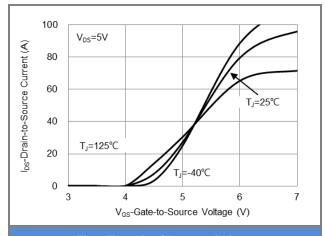


Fig.2 Transfer Characteristics

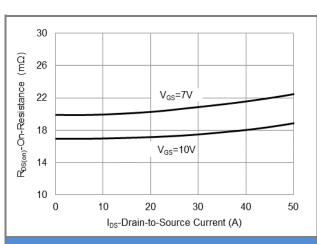


Fig.3 On-Resistance vs. Drain Current

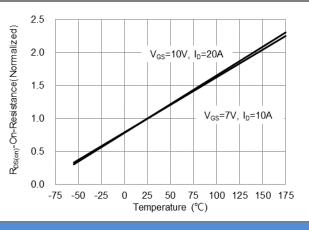
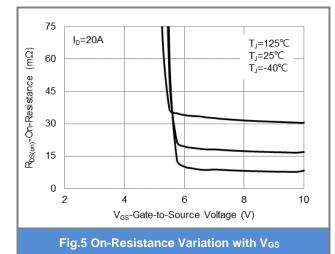
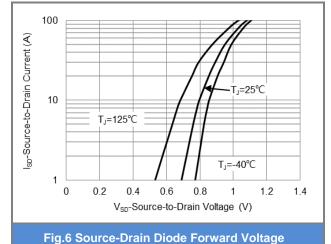


Fig.4 On-Resistance vs. Junction temperature





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TYPICAL CHARACTERISTIC CURVES

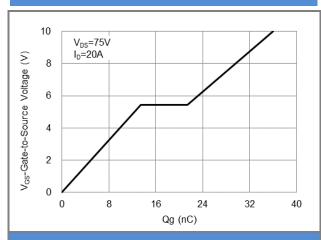


Fig.7 Gate-Charge Characteristics

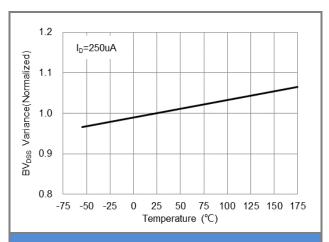


Fig.8 Breakdown Voltage Variation vs. Temperature

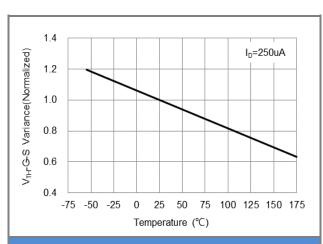


Fig.9 Threshold Voltage Variation with Temperature

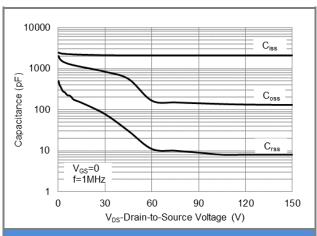
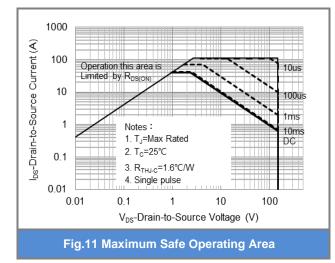


Fig.10 Capacitance vs. Drain-Source Voltage



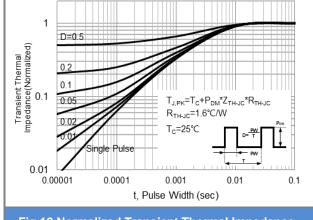


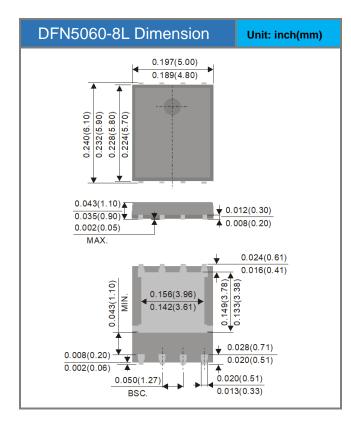
Fig.12 Normalized Transient Thermal Impedance

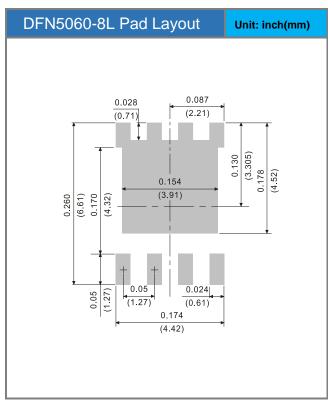


Product and Packing Information

Part No.	Package Type Packing Type		Marking	
PJQ5592-AU	DFN5060-8L	3K pcs / 13" reel	Q5592	

Packaging Information & Mounting Pad Layout







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